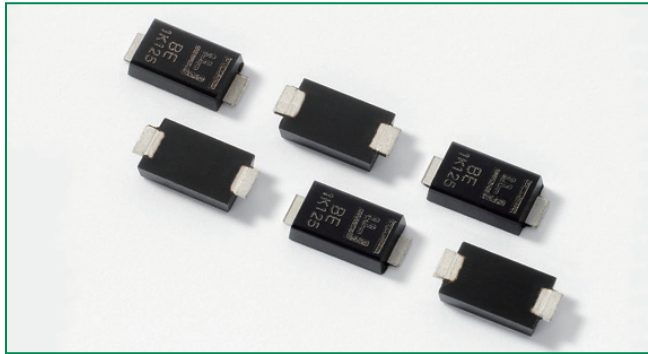


### SMA6L Series

**HF** **RoHS**


#### Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T <sub>A</sub> =25°C by 10x1000µs waveform (Fig.2)(Note 1), (Note 2)	P <sub>PPM</sub>	600	W
Power Dissipation on infinite heat sink at T <sub>A</sub> =50°C	P <sub>MAV</sub>	3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	60	A
Maximum Instantaneous Forward Voltage at 25A for Unidirectional only	V <sub>F</sub>	3.5V	V
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to 150	°C
Typical Thermal Resistance Junction to Lead	R <sub>uJL</sub>	35	°C/W
Typical Thermal Resistance Junction to Ambient	R <sub>uJA</sub>	200	°C/W

**Notes:**

1. Non-repetitive current pulse, per Fig.4 and derated above T<sub>A</sub>=25°C per Fig. 3.
2. Mounted on 5.0x5.0mm copper pad to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only.

#### Description

The SMA6L series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

SMA low profile package has the same electrical performance as the SMB package but with lowest height profiles (1.1mm) in the industry.

#### Features

- SMA low profile package: less than 1.1 mm
- Same power as standard SMB devices (600 W)
- Footprint compatibility with standard SMA and SMB products (easy to layout)
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- EFT protection of data lines in accordance with IEC 61000-4-4 (IEC801-4)
- Low inductance, excellent clamping capability
- Fast response time: typically less than 1.0ns from 0 Volts to V<sub>BR</sub> min
- Built-in strain relief
- Glass passivated junction
- Typical I<sub>R</sub> less than 1µA above 12V
- High temperature soldering: 260°C/40 seconds at terminals
- Typical maximum temperature coefficient ΔV<sub>BR</sub> = 0.1% × V<sub>BR</sub>@25°C × ΔT
- Matte tin lead-free plated
- Halogen free and RoHS compliant

#### Applications

TVS devices are ideal for the protection of I/O Interfaces, V<sub>CC</sub> bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

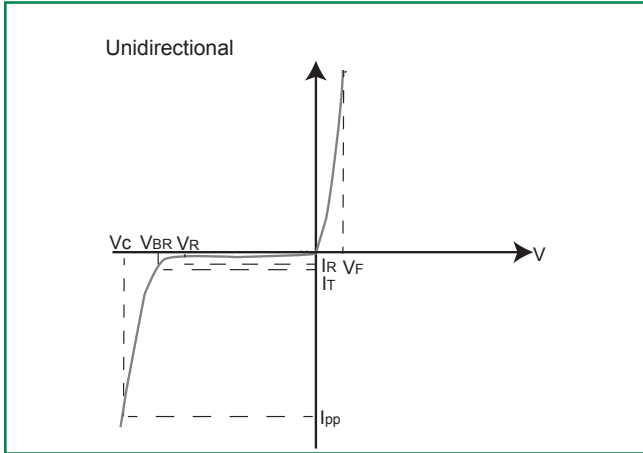
### Electrical Characteristics

Part Number (Uni)	Marking	Reverse Stand off Voltage $V_R$ (Volts)	Breakdown Voltage $V_{BR}$ (Volts) @ $I_T$		Test Current $I_T$ (mA)	Maximum Clamping Voltage $V_C$ @ $I_{PP}$ (V)	Maximum Peak Pulse Current $I_{PP}$ (A)	Maximum Reverse Leakage $I_R$ @ $V_R$ ( $\mu$ A)
	UNI		MIN	MAX				
SMA6L5.0A	AE	5.0	6.40	7.00	10	9.2	65.3	800
SMA6L6.0A	AG	6.0	6.67	7.37	10	10.3	58.3	800
SMA6L6.5A	AK	6.5	7.22	7.98	10	11.2	53.6	500
SMA6L7.0A	AM	7.0	7.78	8.60	10	12.0	50.0	200
SMA6L7.5A	AP	7.5	8.33	9.21	1	12.9	46.6	100
SMA6L8.0A	AR	8.0	8.89	9.83	1	13.6	44.2	50
SMA6L8.5A	AT	8.5	9.44	10.40	1	14.4	41.7	20
SMA6L9.0A	AV	9.0	10.00	11.10	1	15.4	39.0	10
SMA6L10A	AX	10.0	11.10	12.30	1	17.0	35.3	5
SMA6L11A	AZ	11.0	12.20	13.50	1	18.2	33.0	1
SMA6L12A	BE	12.0	13.30	14.70	1	19.9	30.2	1
SMA6L13A	BG	13.0	14.40	15.90	1	21.5	28.0	1
SMA6L14A	BK	14.0	15.60	17.20	1	23.2	25.9	1
SMA6L15A	BM	15.0	16.70	18.50	1	24.4	24.6	1
SMA6L16A	BP	16.0	17.80	19.70	1	26.0	23.1	1
SMA6L17A	BR	17.0	18.90	20.90	1	27.6	21.8	1
SMA6L18A	BT	18.0	20.00	22.10	1	29.2	20.6	1
SMA6L20A	BV	20.0	22.20	24.50	1	32.4	18.6	1
SMA6L22A	BX	22.0	24.40	26.90	1	35.5	16.9	1
SMA6L24A	BZ	24.0	26.70	29.50	1	38.9	15.5	1
SMA6L26A	CE	26.0	28.90	31.90	1	42.1	14.3	1
SMA6L28A*	CG	28.0	31.10	34.40	1	45.4	13.3	1
SMA6L30A*	CK	30.0	33.30	36.80	1	48.4	12.4	1
SMA6L33A*	CM	33.0	36.70	40.60	1	53.3	11.3	1
SMA6L36A*	CP	36.0	40.00	44.20	1	58.1	10.4	1
SMA6L40A*	CR	40.0	44.40	49.10	1	64.5	9.3	1
SMA6L43A*	CT	43.0	47.80	52.80	1	69.4	8.7	1
SMA6L45A*	CV	45.0	50.00	55.30	1	72.7	8.3	1
SMA6L48A*	CX	48.0	53.30	58.90	1	77.4	7.8	1
SMA6L51A*	CZ	51.0	56.70	62.70	1	82.4	7.3	1
SMA6L54A*	RE	54.0	60.00	66.30	1	87.1	6.9	1
SMA6L58A*	RG	58.0	64.40	71.20	1	93.6	6.5	1
SMA6L60A*	RK	60.0	66.70	73.70	1	96.8	6.2	1
SMA6L64A*	RM	64.0	71.10	78.60	1	103.0	5.9	1
SMA6L70A*	RP	70.0	77.80	86.00	1	113.0	5.3	1
SMA6L75A*	RR	75.0	83.30	92.10	1	121.0	5.0	1
SMA6L78A*	RT	78.0	86.70	95.80	1	126.0	4.8	1
SMA6L85A*	RV	85.0	94.40	104.00	1	137.0	4.4	1

**Notes:**

Parts with "\*" are still under development.

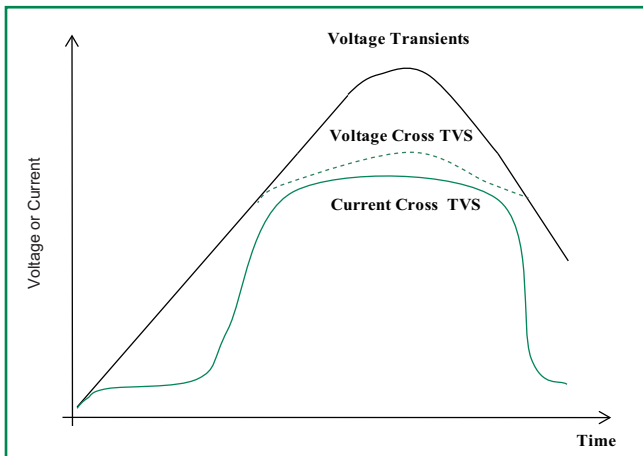
### I-V Curve Characteristics



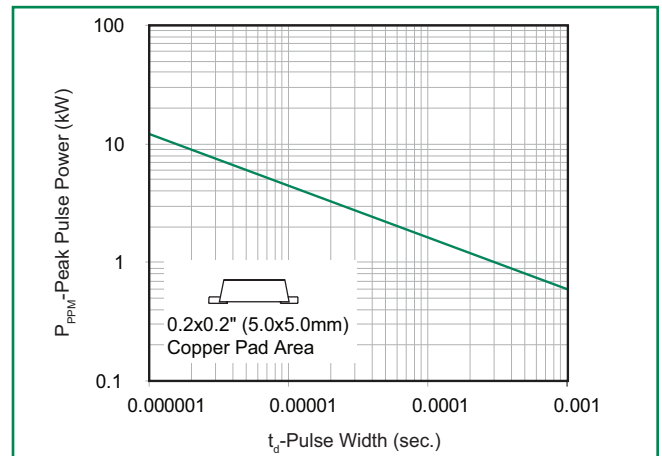
- P<sub>PPM</sub> Peak Pulse Power Dissipation** – Max power dissipation
- V<sub>R</sub> Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V<sub>BR</sub> Breakdown Voltage** – Maximum current that flows through the TVS at a specified test current (I<sub>T</sub>)
- V<sub>c</sub> Clamping Voltage** – Peak voltage measured across the suppressor at a specified I<sub>ppm</sub> (peak impulse current)
- I<sub>R</sub> Reverse Leakage Current** – Current measured at V<sub>R</sub>
- V<sub>F</sub> Forward Voltage Drop for Uni-directional**

### Ratings and Characteristic Curves (T<sub>A</sub> = 25°C unless otherwise noted)

**Figure 1 - TVS Transients Clamping Waveform**



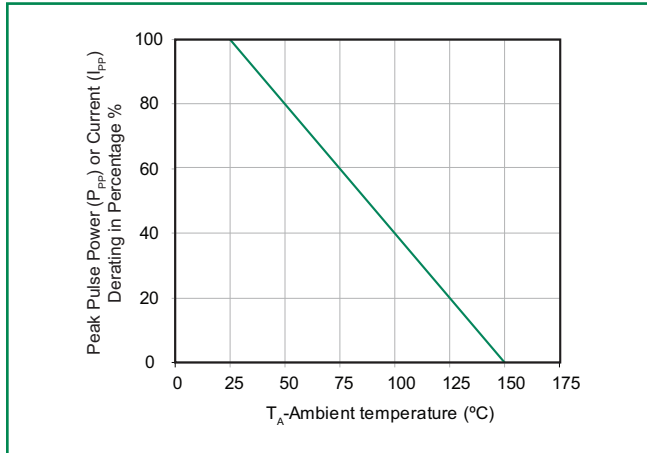
**Figure 2 - Peak Pulse Power Rating Curve**



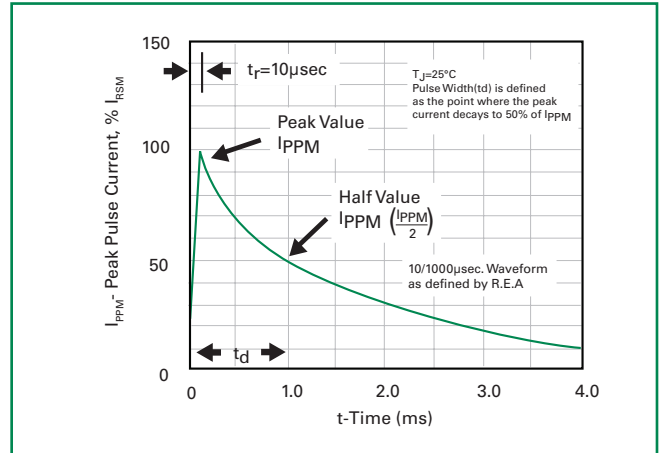
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**Ratings and Characteristic Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted) (Continued)

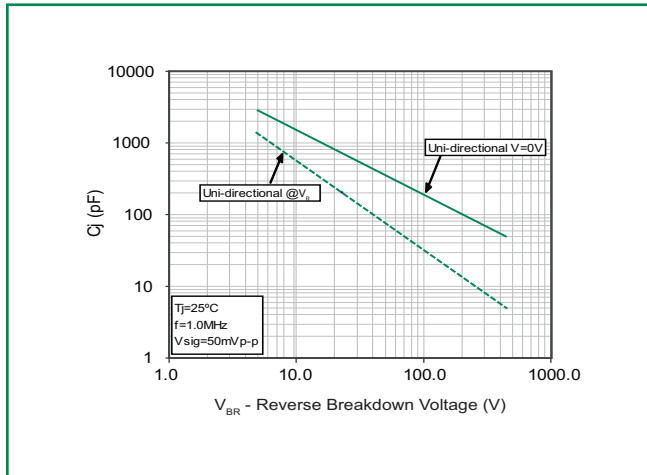
**Figure 3 - Pulse Derating Curve**



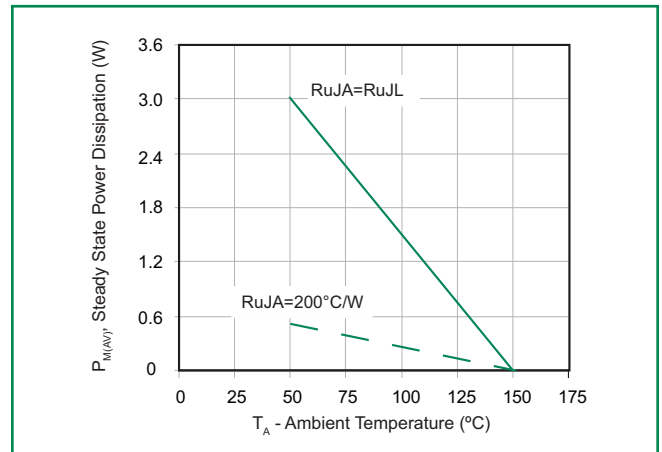
**Figure 4 - Pulse Waveform**



**Figure 5 - Typical Junction Capacitance**

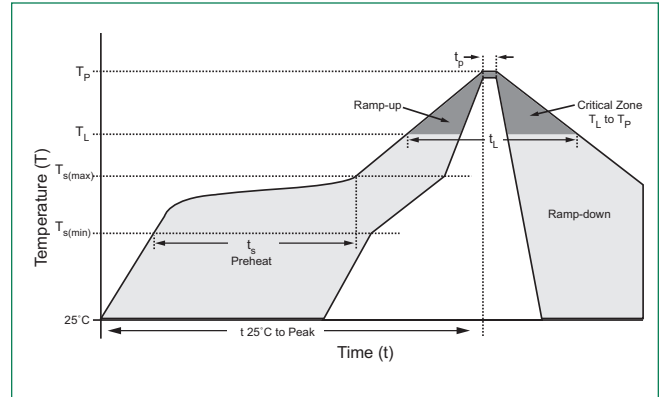


**Figure 6 - Steady State Power Dissipation Derating Curve**



**Soldering Parameters**

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_s$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		280°C



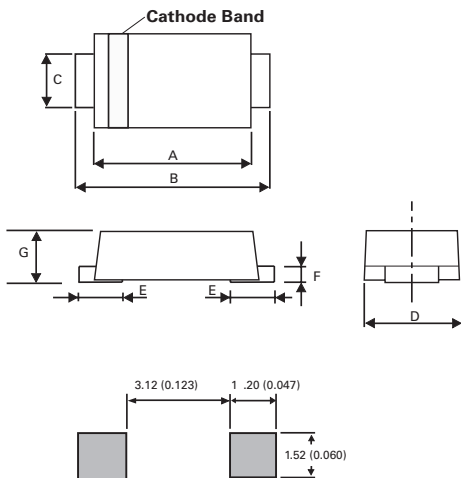
**Physical Specifications**

<b>Weight</b>	0.002 ounce, 0.061 gram
<b>Case</b>	JEDEC DO-221AC Molded Plastic over glass passivated junction
<b>Polarity</b>	Color band denotes cathode except Bipolar
<b>Terminal</b>	Matte Tin-plated leads, Solderable per JESD22-B102D

**Environmental Specifications**

<b>Temperature Cycle</b>	JESD22-A104
<b>Pressure Cooker</b>	JESD22-A102
<b>High Temp. Storage</b>	JESD22-A103
<b>HTRB</b>	JESD22-A108
<b>Thermal Shock</b>	JESD22-A106

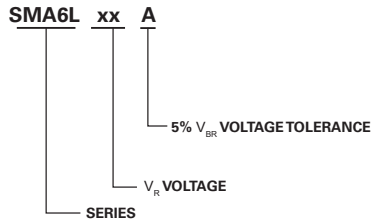
**Dimensions**



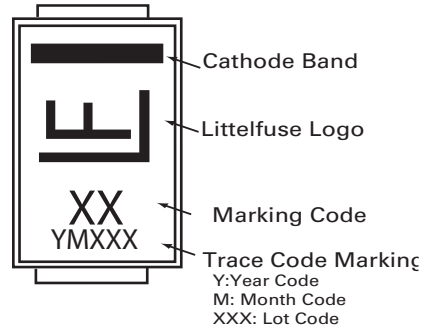
**Mounting Pad Layout**

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.156	0.181	3.950	4.600
B	0.189	0.220	4.800	5.600
C	0.049	0.069	1.250	1.750
D	0.088	0.116	2.250	2.950
E	0.030	0.059	0.750	1.500
F	0.005	0.010	0.125	0.250
G	0.035	0.043	0.900	1.100

### Part Numbering System



### Part Marking System



### Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMA6LxxA	DO-221AC	3000	Tape & Reel – 12mm/7" tape	EIA RS-481

### Tape and Reel Specification

